

N-Channel Enhancement Mode Power MOSFET

■ Features

- DC-DC Application
- Surface Mount Package
- Dual N-channel Device

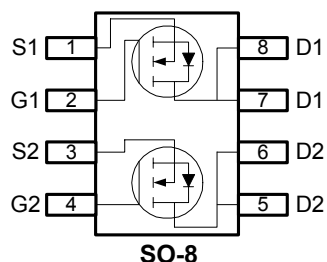
■ General Description

The advanced power MOSFET provides the designer with the best combination of fast switching, ruggedized device design, ultra low on-resistance and cost-effectiveness.

■ Product Summary

BV_{DSS} (V)	$R_{DS(ON)}$ (m Ω)	I_D (A)
30	50	5

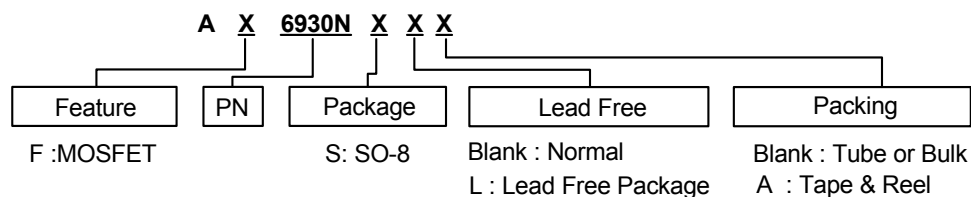
■ Pin Assignments



■ Pin Descriptions

Pin Name	Description
S1/2	Source
G1/2	Gate
D1/2	Drain

■ Ordering information



**N-Channel Enhancement Mode Power MOSFET****■ Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Continuous Drain Current (Note 1)	$T_A=25^\circ\text{C}$	A
		$T_A=70^\circ\text{C}$	
I_{DM}	Pulsed Drain Current (Note 2)	20	A
P_D	Total Power Dissipation	$T_A=25^\circ\text{C}$	W
	Linear Derating Factor		
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

■ Thermal Data

Symbol	Parameter	Maximum	Units
$R_{thj-amb}$	Thermal Resistance Junction-ambient (Note 1) Max.	62.5	$^\circ\text{C/W}$

■ Electrical Characteristics at $T_J=25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	30	-	-	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	Reference to 25°C , $I_D=1\text{mA}$	-	0.037	-	$\text{V}/^\circ\text{C}$
$R_{DS(on)}$	Static Drain-Source On-Resistance (Note 3)	$V_{GS}=10\text{V}, I_D=5\text{A}$	-	-	50	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_D=3.9\text{A}$	-	-	80	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1	-	3	V
g_{fs}	Forward Transconductance	$V_{DS}=15\text{V}, I_D=5\text{A}$	-	6	-	S
I_{DSS}	Drain-Source Leakage Current ($T_J=25^\circ\text{C}$)	$V_{DS}=30\text{V}, V_{GS}=0\text{V}$	-	-	1	μA
	Drain-Source Leakage Current ($T_J=70^\circ\text{C}$)	$V_{DS}=24\text{V}, V_{GS}=0\text{V}$	-	-	25	
I_{GSS}	Gate-Source Leakage	$V_{GS}=\pm 20\text{V}$	-	-	± 100	nA
Q_g	Total Gate Charge (Note 3)	$I_D=5\text{A}$	-	6.1	-	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=15\text{V}$	-	1.4	-	
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{GS}=5\text{V}$	-	3.3	-	
$t_{d(on)}$	Turn-On Delay Time (Note 3)	$V_{DS}=15\text{V}$	-	6.7	-	ns
t_r	Rise Time	$I_D=1.5\text{A}$	-	6.4	-	
$t_{d(off)}$	Turn-Off Delay Time	$R_G=3.3\Omega, V_{GS}=10\text{V}$	-	22.1	-	
t_f	Fall-Time	$R_D=10\Omega$	-	2.1	-	
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}$	-	240	-	pF
C_{oss}	Output Capacitance	$V_{DS}=25\text{V}$	-	145	-	
C_{rss}	Reverse Transfer Capacitance	$f=1.0\text{MHz}$	-	55	-	

■ Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current (Body Diode)	$V_D=V_G=0\text{V}, V_S=1.2\text{V}$	-	-	1.67	V
V_{SD}	Forward On Voltage (Note 3)	$T_J=25^\circ\text{C}, I_S=1.7\text{A}, V_{GS}=0\text{V}$	-	-	1.2	V

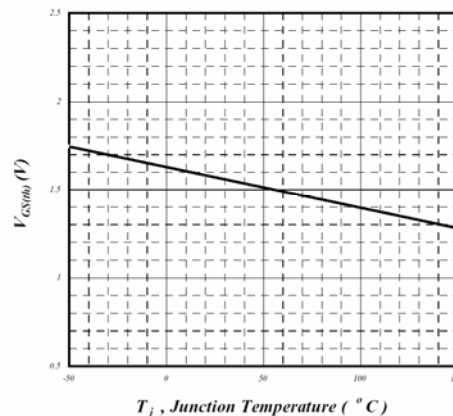
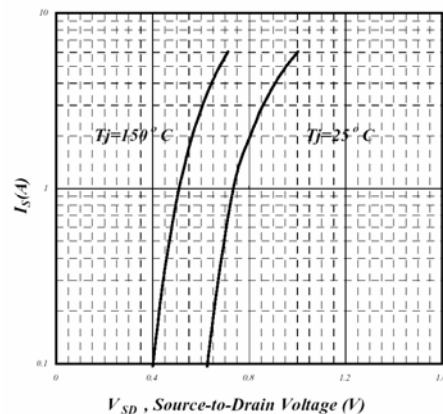
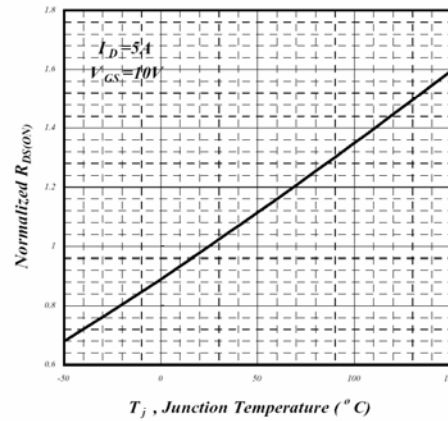
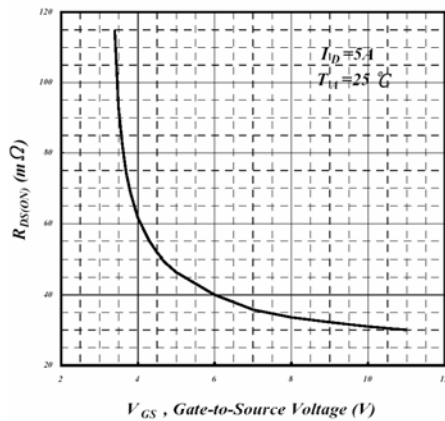
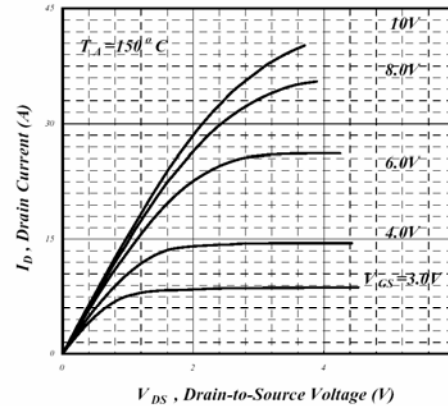
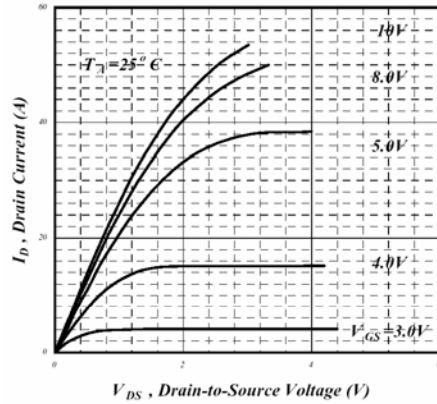
Note 1: Surface mounted on 1 in² copper pad of FR4 board; 135 $^\circ\text{C/W}$ when mounted on Min. copper pad.

Note 2: Pulse width limited by Max. junction temperature.

Note 3: Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.

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Typical Performance Characteristics



N-Channel Enhancement Mode Power MOSFET

■ Typical Performance Characteristics (Continued)

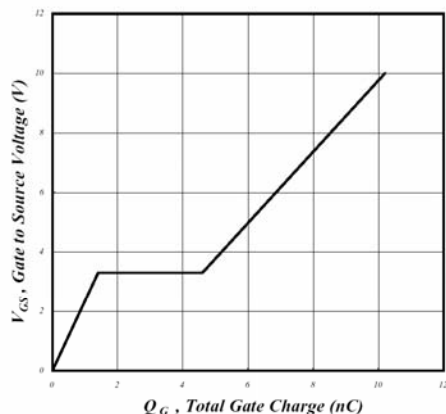


Fig7. Gate Charge Characteristics

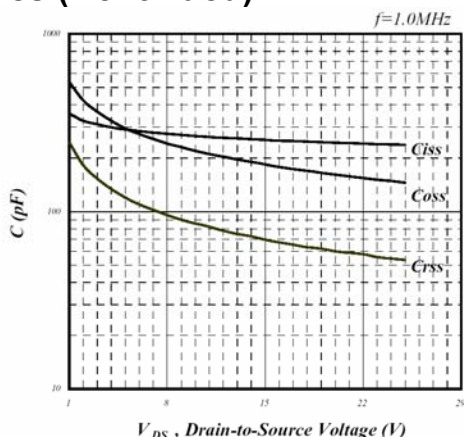


Fig 8 . Typical Capacitance Characteristics

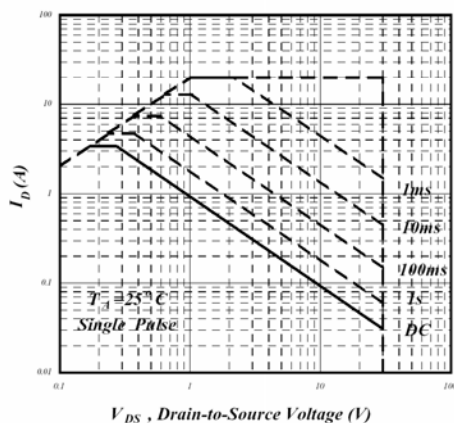


Fig 9. Maximum Safe Operating Area

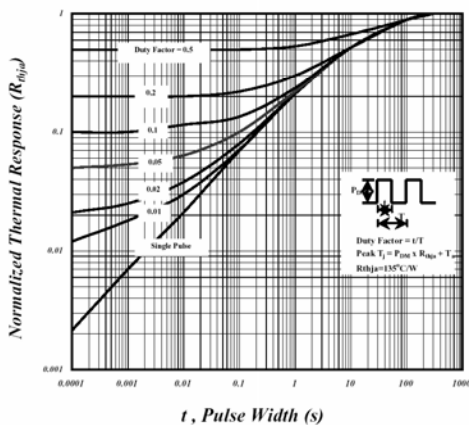


Fig10. Effective Transient Thermal Impedance

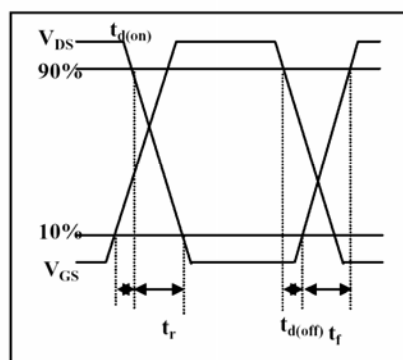


Fig 11. Switching Time Waveform

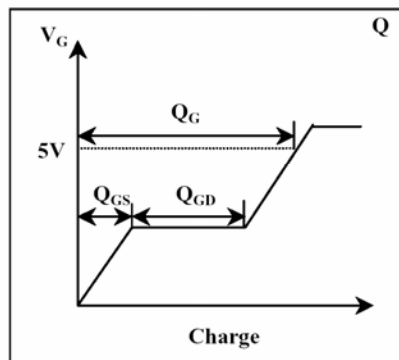
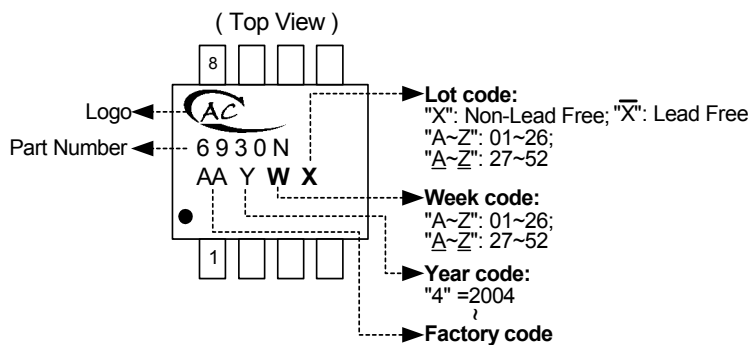


Fig 12. Gate Charge Waveform

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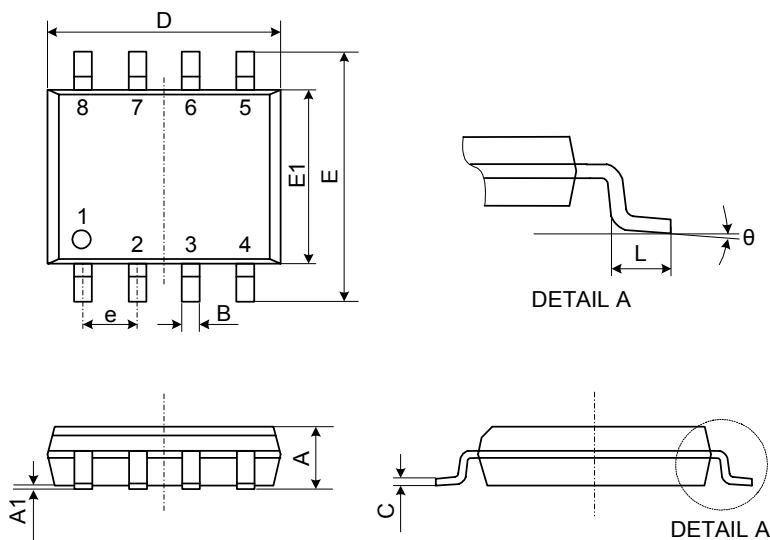
■ Marking Information

SO-8



■ Package Information

Package Type: SO-8



1. All Dimensions Are in Millimeters.
2. Dimension Does Not Include Mold Protrusions.

Symbol	Dimensions In Millimeters		
	Min.	Nom.	Max.
A	1.35	1.55	1.75
A1	0.10	0.18	0.25
B	0.33	0.41	0.51
C	0.19	0.22	0.25
D	4.80	4.90	5.00
E	5.80	6.15	6.50
E1	3.80	3.90	4.00
L	0.38	0.71	1.27
θ	0°	4°	8°
e	1.27 TYP.		